

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Pri_ rity Application Serial No. 09/579,333
Priority Filing Date May 25, 2000
Inventor..... Paul A. Morgan
Assignee..... Micron Technology, Inc.
Priority Group Art Unit 2812
Priority Examiner Nguyen, H.
Attorney's Docket No. MI22-2411
Title: Methods of Cleaning Surfaces of Copper-Containing Materials, and Methods of
Forming Openings to Copper-Containing Substrates

PRELIMINARY AMENDMENT

To: MS Patent Application
Commissioner for Patents
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AMENDMENTS

Introductory Comments

This preliminary amendment accompanies filing of a continuation application.
Applicant amends the application and remarks as follows.